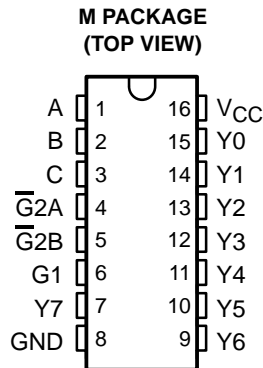


- **AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply Voltage**
- **Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption**
- **Designed Specifically for High-Speed Memory Decoders and Data-Transmission Systems**
- **Incorporates Three Enable Inputs to Simplify Cascading and/or Data Reception**
- **Balanced Propagation Delays**
- **±24-mA Output Drive Current**
– Fanout to 15 F Devices
- **SCR-Latchup-Resistant CMOS Process and Circuit Design**
- **Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015**



description/ordering information

The CD74AC238 decoder/demultiplexer is designed for high-performance memory-decoding and data-routing applications that require very short propagation-delay times. In high-performance memory systems, this decoder can be used to minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay times of this decoder and the enable time of the memory usually are less than the typical access time of the memory. This means that the effective system delay introduced by the decoder is negligible.

The conditions at the binary-select inputs and the three enable inputs select one of eight output lines. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters, and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications (see Application Information).

ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	SOIC – M	Tape and reel	CD74AC238M96	AC238M

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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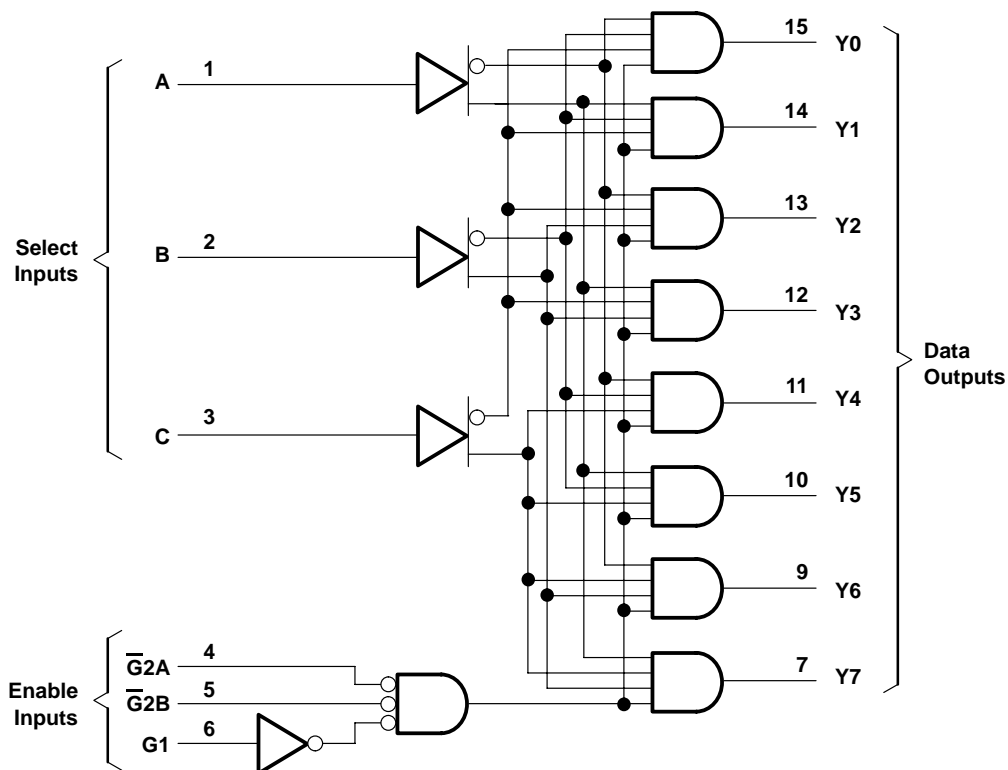
CD74AC238 3-LINE TO 8-LINE DECODER/DEMULTIPLEXER

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FUNCTION TABLE

ENABLE INPUTS			SELECT INPUTS			OUTPUTS							
G1	$\overline{G2A}$	$\overline{G2B}$	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	X	L	L	L	L	L	L	L	L
X	X	H	X	X	X	L	L	L	L	L	L	L	L
L	X	X	X	X	X	L	L	L	L	L	L	L	L
H	L	L	L	L	L	H	L	L	L	L	L	L	L
H	L	L	L	L	H	L	H	L	L	L	L	L	L
H	L	L	L	H	L	L	L	H	L	L	L	L	L
H	L	L	L	H	H	L	L	L	H	L	L	L	L
H	L	L	H	L	L	L	L	L	L	H	L	L	L
H	L	L	H	L	H	L	L	L	L	L	H	L	L
H	L	L	H	H	L	L	L	L	L	L	L	H	L
H	L	L	H	H	H	L	L	L	L	L	L	L	H

logic diagram (positive logic)



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 6 V
Input clamp current, I_{IK} ($V_I < 0$ V or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ V or $V_O > V_{CC}$) (see Note 1)	±50 mA
Continuous output current, I_O ($V_O > 0$ V or $V_O < V_{CC}$)	±50 mA
Continuous current through V_{CC} or GND	±200 mA
Package thermal impedance, θ_{JA} (see Note 2)	73°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		$T_A = 25^\circ\text{C}$		$-55^\circ\text{C to } 125^\circ\text{C}$		$-40^\circ\text{C to } 85^\circ\text{C}$		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	1.5	5.5	1.5	5.5	1.5	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 1.5$ V		1.2		1.2		V
		$V_{CC} = 3$ V		2.1		2.1		
		$V_{CC} = 5.5$ V		3.85		3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 1.5$ V			0.3		0.3	V
		$V_{CC} = 3$ V			0.9		0.9	
		$V_{CC} = 5.5$ V			1.65		1.65	
V_I	Input voltage	0	V_{CC}	0	V_{CC}	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 4.5$ V to 5.5 V		–24		–24		mA
I_{OL}	Low-level output current	$V_{CC} = 4.5$ V to 5.5 V		24		24		mA
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 1.5$ V to 3 V		50		50		ns/V
		$V_{CC} = 3.6$ V to 5.5 V		20		20		

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C		-55°C to 125°C		-40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
V _{OH}	V _I = V _{IH} or V _{IL}	I _{OH} = -50 μA	1.5 V	1.4	1.4	1.4			V
			3 V	2.9	2.9	2.9			
			4.5 V	4.4	4.4	4.4			
		I _{OH} = -4 mA	3 V	2.58	2.4	2.48			
		I _{OH} = -24 mA	4.5 V	3.94	3.7	3.8			
		I _{OH} = -50 mA†	5.5 V		3.85				
		I _{OH} = -75 mA†	5.5 V			3.85			
V _{OL}	V _I = V _{IH} or V _{IL}	I _{OL} = 50 μA	1.5 V	0.1	0.1	0.1			V
			3 V	0.1	0.1	0.1			
			4.5 V	0.1	0.1	0.1			
		I _{OL} = 12 mA	3 V	0.36	0.5	0.44			
		I _{OL} = 24 mA	4.5 V	0.36	0.5	0.44			
		I _{OL} = 50 mA†	5.5 V		1.65				
		I _{OL} = 75 mA†	5.5 V			1.65			
I _I	V _I = V _{CC} or GND	5.5 V		±0.1	±1	±1		μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V		8	160	80		μA	
C _i				10	10	10		pF	

† Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 1.5 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	-55°C to 125°C		-40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	
t _{PLH}	A, B, C	Any Y		187		170	ns
t _{PHL}				187		170	
t _{PLH}	G1	Any Y		208		189	ns
t _{PHL}				208		189	
t _{PLH}	G ₂ A, G ₂ B	Any Y		149		135	ns
t _{PHL}				149		135	



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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	–55°C to 125°C		–40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	
t _{PLH}	A, B, C	Any Y	5.3	21	5.4	19.1	ns
t _{PHL}			5.3	21	5.4	19.1	
t _{PLH}	G1	Any Y	5.8	23.2	6	21.1	ns
t _{PHL}			5.8	23.2	6	21.1	
t _{PLH}	$\overline{G}2A, \overline{G}2B$	Any Y	4.2	16.7	4.3	15.2	ns
t _{PHL}			4.2	16.7	4.3	15.2	

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	–55°C to 125°C		–40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	
t _{PLH}	A, B, C	Any Y	3.8	15	3.9	13.6	ns
t _{PHL}			3.8	15	3.9	13.6	
t _{PLH}	G1	Any Y	4.2	16.6	4.3	15.1	ns
t _{PHL}			4.2	16.6	4.3	15.1	
t _{PLH}	$\overline{G}2A, \overline{G}2B$	Any Y	3	11.9	3.1	10.7	ns
t _{PHL}			3	11.9	3.1	10.7	

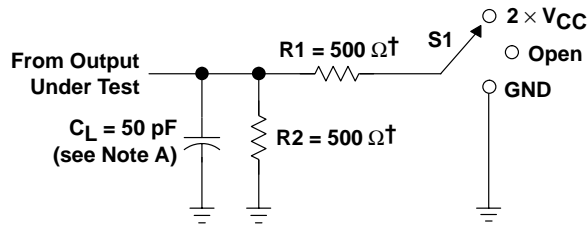
operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TYP	UNIT
C _{pd}	Power dissipation capacitance	110	pF

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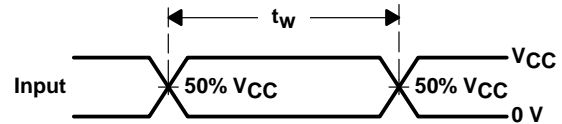
PARAMETER MEASUREMENT INFORMATION



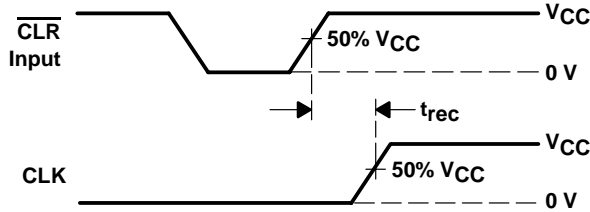
† When $V_{CC} = 1.5\text{ V}$, $R1 = R2 = 1\text{ k}\Omega$

LOAD CIRCUIT

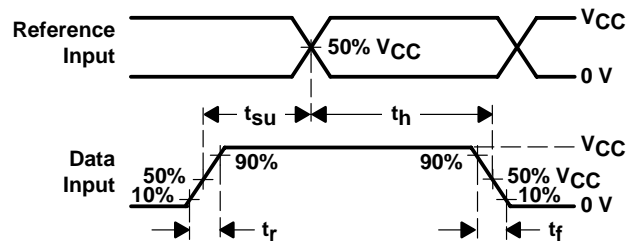
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND



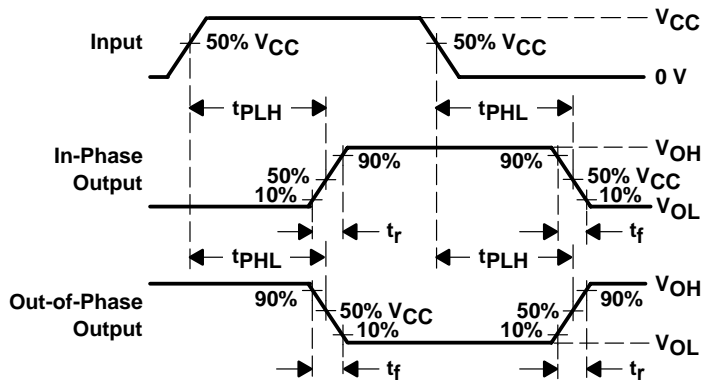
VOLTAGE WAVEFORMS
PULSE DURATION



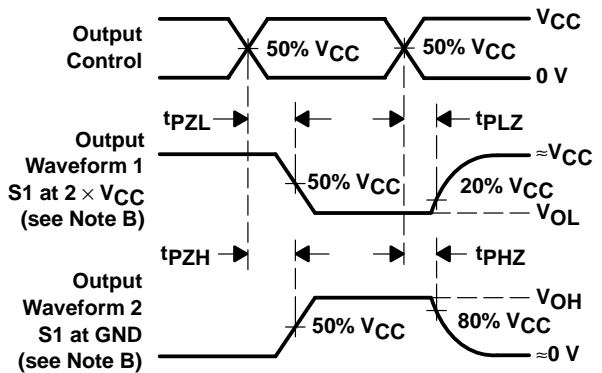
VOLTAGE WAVEFORMS
RECOVERY TIME



VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES



VOLTAGE WAVEFORMS
OUTPUT ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and test-fixture capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r = 3\text{ ns}$, $t_f = 3\text{ ns}$. Phase relationships between waveforms are arbitrary.
 - For clock inputs, f_{max} is measured with the input duty cycle at 50%.
 - The outputs are measured one at a time with one input transition per measurement.
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

APPLICATION INFORMATION

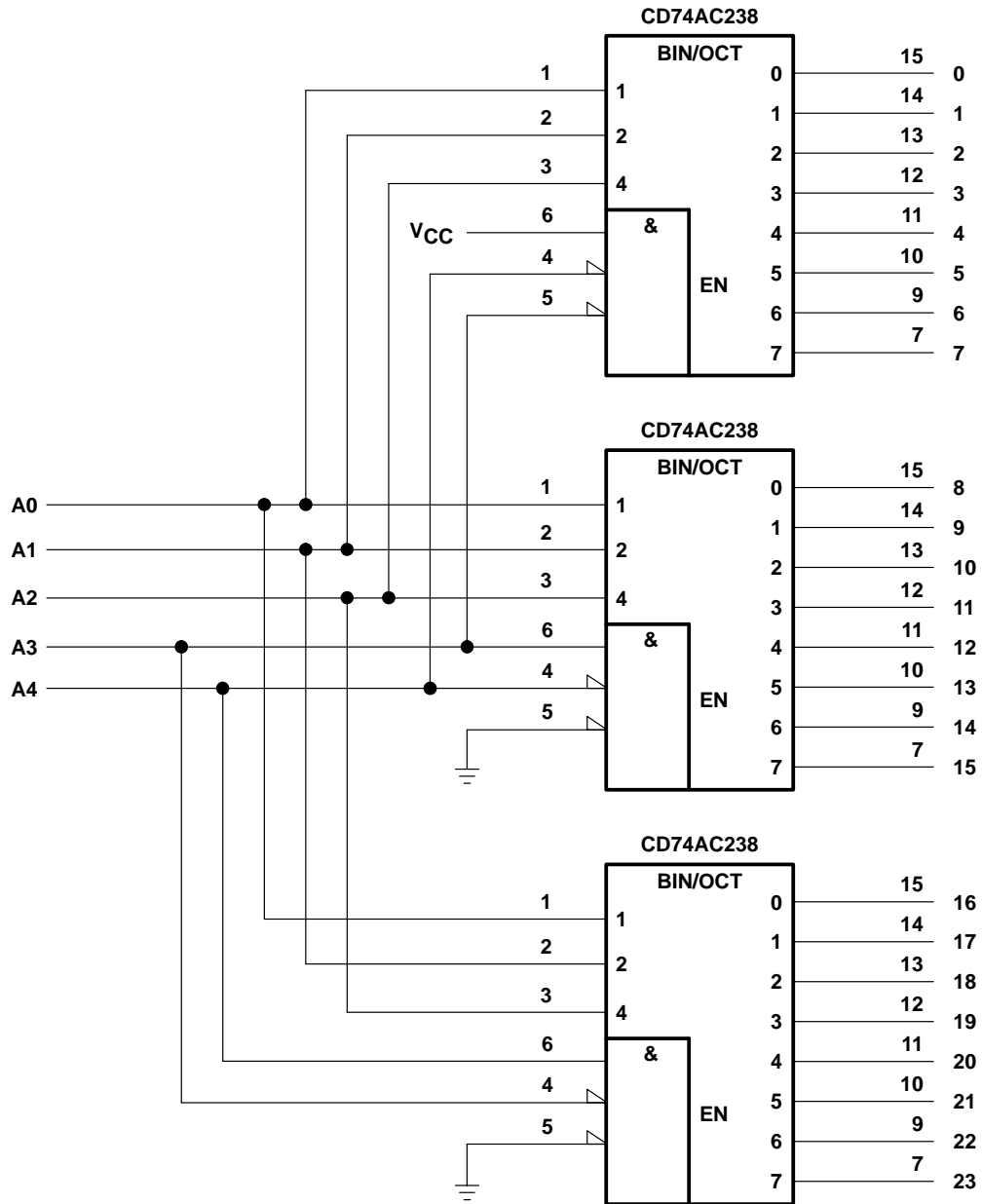


Figure 2. 24-Bit Decoding Scheme

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APPLICATION INFORMATION

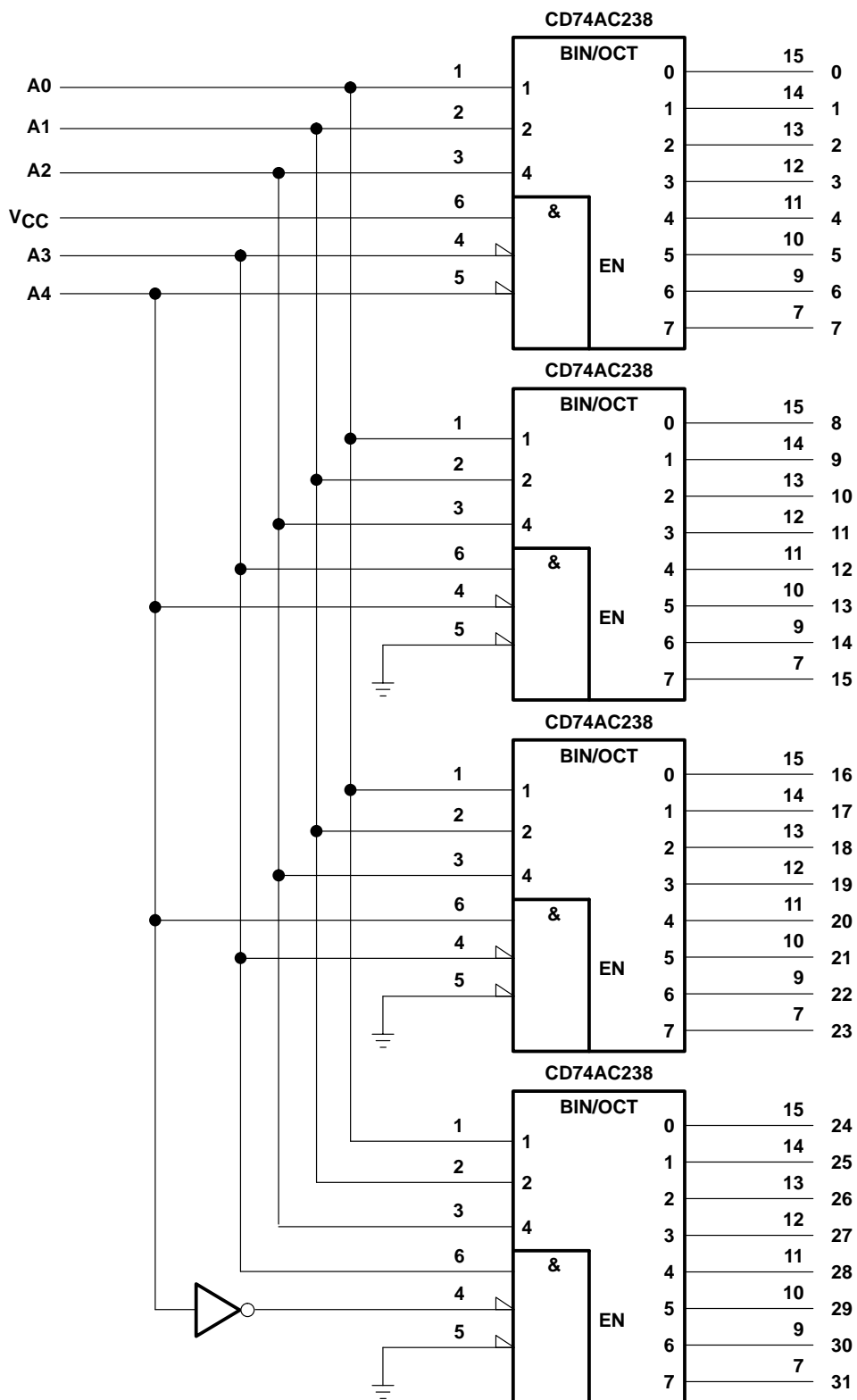
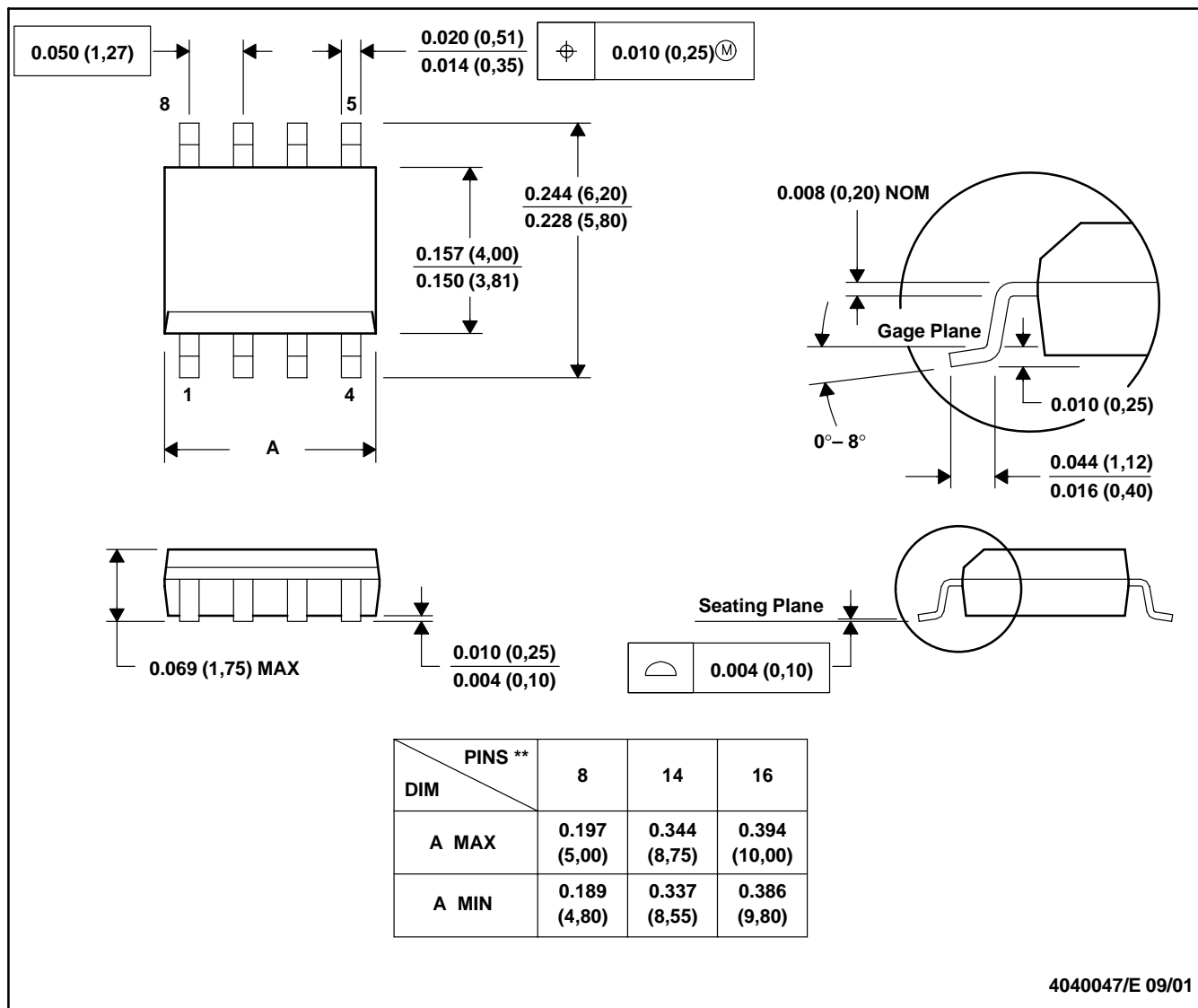


Figure 3. 32-Bit Decoding Scheme

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265